

# 1.5 MHz, 1000mA Synchronous Step-Down Converter

### GENERAL DESCRIPTION

The GX3410 is a 1.5MHz constant frequency, slope compensated current mode PWM stepdown converter. The device integrates a main switch and a synchronous rectifier for high efficiency without an external Schottky diode. It is ideal for powering portable equipment that runs from a single cell lithium-lon (Li+) battery. The GX3410 can supply 1000mA of load current from a 2.0V to 6.0V input voltage. The output voltage can be regulated as low as 0.6V. The GX3410 can also run at 100% duty cycle for low dropout operation, extending battery life in portable system. Pulse Skipping Mode operation at light loads provides very low output ripple voltage for noise sensitive applications.

The GX3410 is offered in a low profile (1mm) 5-pin, SOT package, and 6-pin, DFN-6 package, and is available in an adjustable version and fixed output voltage of 1.2V,1.5V and 1.8V.

### **APPLICATIONS**

- Cellular and Smart Phones
- Microprocessors and DSP Core Supplies
- Wireless and DSL Modems
- PDAs
- MP3 Player
- Digital Still and Video Cameras
- Portable Instruments

### **FEATURES**

- High Efficiency: Up to 96%
- 1.5MHz Constant Switching Frequency
- 1000mA Output Current at V<sub>IN</sub>=5V
- Integrated Main switch and synchronous rectifier. No Schottky Diode Required
- 2.0V to 6.0V Input Voltage Range
- 6.0V Input overvoltage protection
- Output Voltage as Low as 0.6V
- 100% Duty Cycle in Dropout
- Low Quiescent Current: 40uA
- Slope Compensated Current Mode Control for Excellent Line and Load Transient Response
- Short Circuit Protection
- Thermal Fault Protection
- <1µA Shutdown Current</li>
- Space Saving 5-Pin SOT23 package

### **EVALUATION BOARD**

| Standard Demo Board | Dimensions (mm)  |  |  |
|---------------------|------------------|--|--|
| GX3410ET5-02        | 60X x 60Y x 1.6Z |  |  |

# **Typical Application**

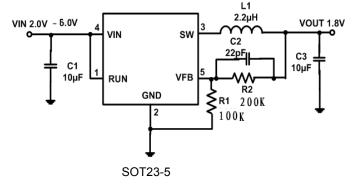


Figure 1. Basic Application Circuit with GX3410 adjustable version, Vout = 1.8V

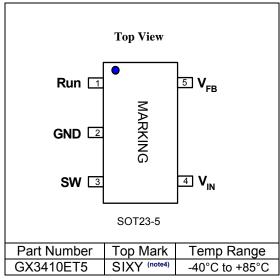
# **Absolute Maximum Rating** (Note 1)

| Input Supply Voltage          | 0.3V to +7.5V |
|-------------------------------|---------------|
| RUN, V <sub>FB</sub> Voltages |               |
| SW, Vout Voltages             | ***           |
| Peak SW Sink and Source Cur   | ***           |

Operating Temperature Range... -40°C to +85°C Junction Temperature (Note2).....+125°C Storage Temperature Range .... -65°C to +150°C Lead Temperature (Soldering, 10s).....+300°C

# **Package/Order Information**

### **Adjustable Output Version:**



## Thermal Resistance (Note 3):

| Package | $\Theta_{JA}$ | Θ <sub>JC</sub> |  |
|---------|---------------|-----------------|--|
| SOT23-5 | 250°C/W       | 110°C/W         |  |

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

Note 2: T<sub>J</sub> is calculated from the ambient temperature T<sub>A</sub> and power dissipation P<sub>D</sub> according to the following formula:  $T_{.I} = T_A + P_D \times \Theta_{.IA}$ .

**Note 3:** Thermal Resistance is specified with approximately 1 square of 1 oz copper.

Note 4: XY = Manufacturing Date Code

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## **Electrical Characteristics** (Note 5)

 $(V_{IN} = V_{RUN} = 3.6V, TA = 25^{\circ}C, Test Circuit Figure 1, unless otherwise noted.)$ 

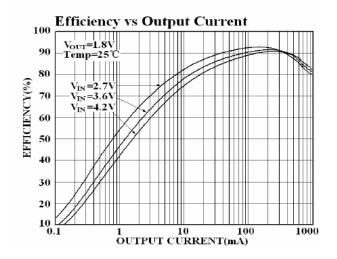
| Parameter   | Conditions   | MIN                        | TYP                        | MAX                        | unit     |
|---|--|----------------------------|----------------------------|----------------------------|----------|
| Input Voltage Range                                     |  | 2.0                        |                            | 6.0                        | ٧        |
| Input DC Supply Current<br>Active Mode<br>Shutdown Mode | V <sub>FB</sub> =0.5V<br>V <sub>FB</sub> =0V, V <sub>IN</sub> =4.2V  |                            | 40<br>0.08                 | 70<br>1.0                  | μΑ<br>μΑ |
| UVLO Threshold  |  |                            | 2.4                        |                            |          |
| OVP Threshold   |  |                            | 6.0                        |                            |          |
| Regulated Feedback<br>Voltage                           | $T_A = +25^{\circ}C$ $T_A = 0^{\circ}C \le T_A \le 85^{\circ}C$ $T_A = -40^{\circ}C \le T_A \le 85^{\circ}C$ | 0.5880<br>0.5865<br>0.5850 | 0.6000<br>0.6000<br>0.6000 | 0.6120<br>0.6135<br>0.6150 | V<br>V   |
| V <sub>FB</sub> Input Bias Current                      | $V_{FB} = 0.65V$   | 0.0000                     | 0.0000                     | ±30                        | nA       |
| Reference Voltage Line<br>Regulation                    | $V_{IN}$ = 2.5V to 5.5V, $V_{OUT}$ = $V_{FB}$ (R2=0)   |                            | 0.11                       | 0.40                       | %/V      |
| Regulated Output Voltage                                | GX3410ET5-1.5, -40°C≤T <sub>A</sub> ≤ 85°C   | 1.164<br>1.455<br>1.746    | 1.200<br>1.500<br>1.800    | 1.236<br>1.545<br>1.854    | V<br>V   |
| Output Voltage Line<br>Regulation                       | V <sub>IN</sub> = 2.5V to 5.5V, I <sub>OUT</sub> =10mA   |                            | 0.11                       | 0.40                       | %/V      |
| Output Voltage Load<br>Regulation                       | I <sub>OUT</sub> from 10 to1000mA  |                            | 0.002                      |                            | %/mA     |
| Maximum Output Current                                  | V <sub>IN</sub> = 5.0V   | 1000                       |                            |                            | mA       |
| Oscillator Frequency                                    | V <sub>FB</sub> =0.6V or V <sub>OUT</sub> =100%  | 1.2                        | 1.5                        | 1.8                        | MHz      |
| R <sub>DS(ON)</sub> of P-CH MOSFET                      | I <sub>SW</sub> = 300mA  |                            | 0.23                       | 0.45                       | Ω        |
| R <sub>DS(ON)</sub> of N-CH MOSFET                      | I <sub>SW</sub> = -300mA   |                            | 0.19                       | 0.38                       | Ω        |
| Peak Inductor Current                                   | V <sub>IN</sub> =3V, V <sub>FB</sub> =0.5V or V <sub>OUT</sub> =90%<br>Duty Cycle <35%                       |                            | 1.20                       |                            | Α        |
| SW Leakage  | V <sub>RUN</sub> = 0V, V <sub>SW</sub> = 0V or 5V, V <sub>IN</sub> = 5V                                      |                            | ±0.01                      | ±1                         | μΑ       |
| Output over voltage lockout                             | $\Delta V_{OVL} = V_{OVL} - V_{FB}$  |                            | 60                         |                            | mV       |
| RUN Threshold   | -40°C ≤ T <sub>A</sub> ≤ 85°C  | 1.5                        |                            |                            | V        |
| RUN Leakage Current                                     |  |                            | ±0.1                       | ±1                         | μA       |

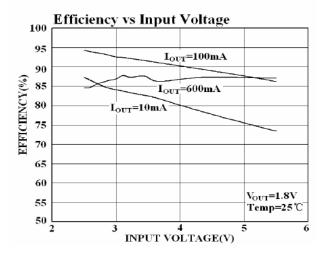
**Note 5:** 100% production test at +25°C. Specifications over the temperature range are guaranteed by design and characterization.

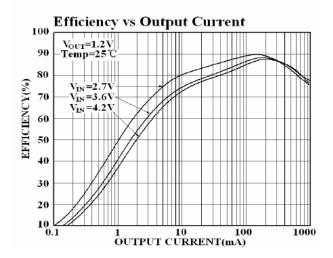
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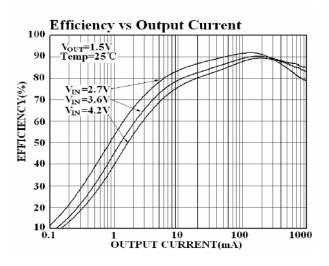


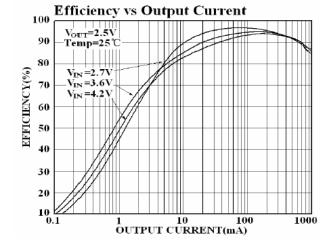
# Typical Performance Characteristics (Test Figure 1 above unless otherwise specified)

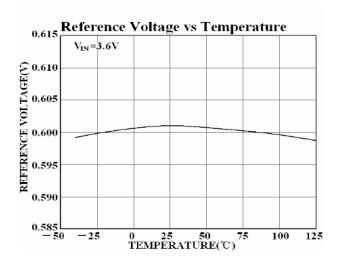






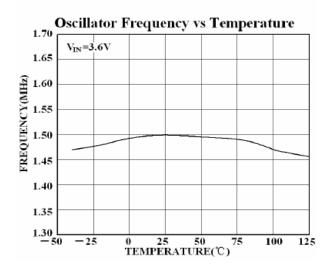


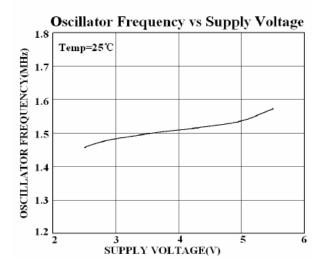


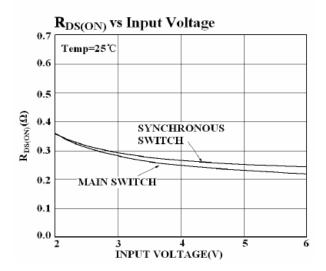


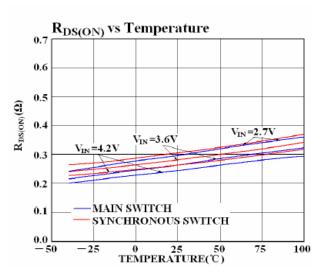
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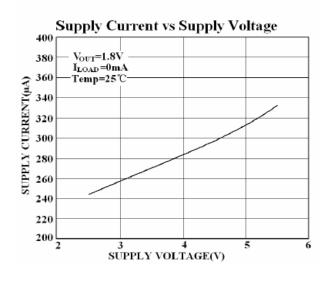


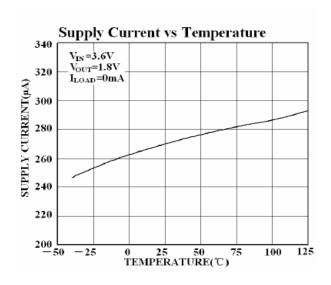








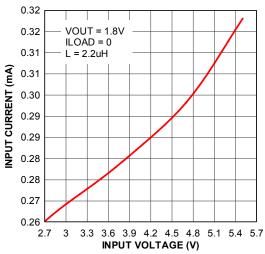




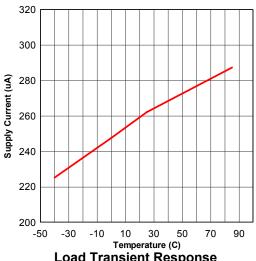
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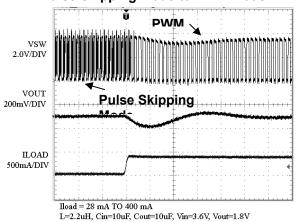
# Input Voltage vs Input Current



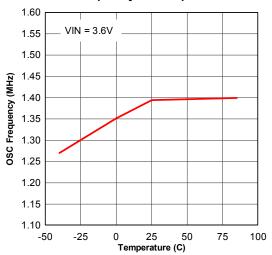
**Supply Current vs Temperature** 



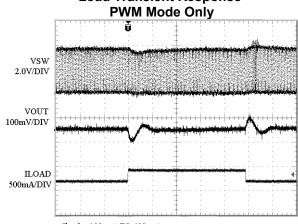
Load Transient Response
Pulse Skipping Mode to PWM Mode



#### Frequency vs Temperature



### Load Transient Response



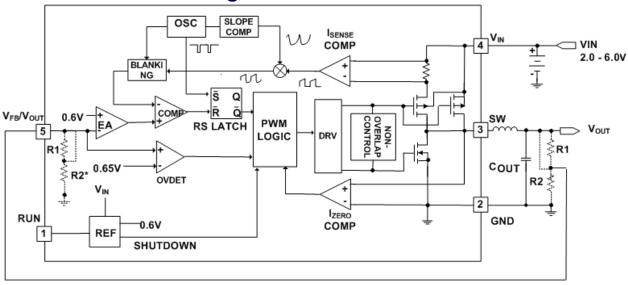
 $\label{eq:load} \begin{tabular}{l} $\rm Iload=100~mA~TO~400~mA$\\ $\rm L\!\!=\!\!2.2uH,~Cin\!\!=\!\!10uF,~Cout\!\!=\!\!10uF,~Vin\!\!=\!\!3.6V,~Vout\!\!=\!\!1.8V$\\ \end{tabular}$ 



# **Pin Description SOT23-5**

| PIN | NAME     | FUNCTION   |  |  |  |
|-----|----------|--|--|--|--|
| 1   | RUN      | Regulator Enable control input. Drive RUN above 1.5V to turn on the part. Drive RUN below 0.3V to turn it off. In shutdown, all functions are disabled drawing <1µA supply current. Do not leave RUN floating.   |  |  |  |
| 2   | GND      | Ground   |  |  |  |
| 3   | SW       | Power Switch Output. It is the Switch note connection to Inductor. This pin connects to the drains of the internal P-CH and N-CH MOSFET switches.  |  |  |  |
| 4   | IN       | Supply Input Pin. Must be closely decoupled to GND, Pin 2, with a 2.2µF or greater ceramic capacitor.  |  |  |  |
| 5   | VFB/VOUT | VFB(GX3410ET5): Feedback Input Pin. Connect FB to the center point of the external resistor divider. The feedback threshold voltage is 0.6V. VOUT(GX3410ET5-1.2/GX3410ET5-1.5/GX3410ET5-1.8). Output Voltage Feedback Pin. An internal resistive divider divides the output voltage down for comparison to the internal reference voltage. |  |  |  |

# **Functional Block Diagram**



<sup>\*</sup> FOR ADJUSTABLE OUTPUT R1+R2 IS EXTERNAL

Figure 2. GX3410 Block Diagram

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# **Operation**

GX3410 is a monolithic switching mode Step-Down DC-DC converter. It utilizes internal MOSFETs to achieve high efficiency and can generate very low output voltage by using internal reference at 0.6V. It operates at a fixed switching frequency, and uses the slope compensated current mode architecture. This Step-Down DC-DC Converter supplies1000mA output current at VIN = 5V with input voltage range from 2.0V to 6.0V.

#### **Current Mode PWM Control**

Slope compensated current mode PWM control provides stable switching and cycle-by-cycle current limit for excellent load and line responses and protection of the internal main switch (P-Ch MOSFET) and synchronous rectifier (N-CH MOSFET). During normal operation, the internal P-Ch MOSFET is turned on for a certain time to ramp the inductor current at each rising edge of the internal oscillator, and switched off when the peak inductor current is above the error voltage. The current comparator, I<sub>COMP.</sub> limits the peak inductor current. When the main switch is off, the synchronous rectifier will be turned immediately and stay on until either the inductor current starts to reverse, as indicated by the current reversal comparator, IZERO, or the beginning of the next clock cycle. The OVDET comparator controls output transient overshoots by turning the main switch off and keeping it off until the fault is no longer present.

### **Pulse Skipping Mode Operation**

At very light loads, the GX3410 automatically enters Pulse Skipping Mode. In the Pulse Skipping Mode, the inductor current may reach zero or reverse on each pulse. The PWM control loop will automatically skip pulses to maintain output regulation. The bottom MOSFET is turned off by the current reversal comparator,  $I_{ZERO}$ , and the switch voltage will ring. This is discontinuous mode operation, and is normal behavior for the switching regulator.

### **Dropout Operation**

When the input voltage decreases toward the value of the output voltage, the GX3410 allows the main switch to remain on for more than one switching cycle and increases the duty cycle (Note 5) until it reaches 100%. The output voltage then is the input voltage minus the voltage drop across the main switch and the inductor. At low input supply voltage, the  $R_{\rm DS(ON)}$  of the P-Channel MOSFET increases, and the efficiency of the converter decreases. Caution must be exercised to ensure the heat dissipated not to exceed the maximum junction temperature of the IC.

**Note 5:** The duty cycle D of a step-down converter is defined as:

$$D = T_{ON} \times f_{OSC} \times 100\% \approx \frac{V_{OUT}}{V_{IN}} \times 100\%$$

Where  $T_{ON}$  is the main switch on time and  $f_{OSC}$  is the oscillator frequency (1.4Mhz).

#### **Maximum Load Current**

The GX3410 will operate with input supply voltage as low as 2.0V, however, the maximum load current decreases at lower input due to large IR drop on the main switch and synchronous rectifier. The slope compensation signal reduces the peak inductor current as a function of the duty cycle to prevent sub-harmonic oscillations at duty cycles greater than 50%. Conversely the current limit increases as the duty cycle decreases.

# **Layout Guidance**

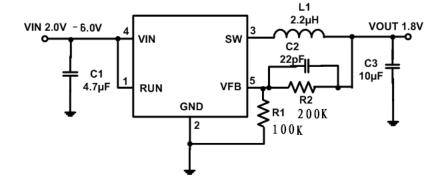
When laying out the PC board, the following suggestions should be taken to ensure proper operation of the GX3410. These items are also illustrated graphically in Figure 3.

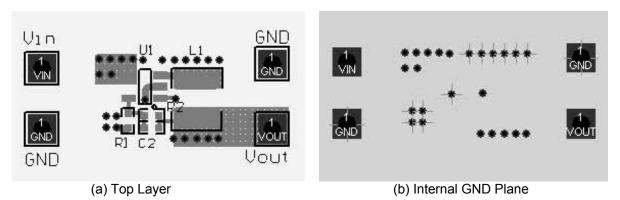
- The power traces, including the GND trace, the SW trace and the VIN trace should be kept short, direct and wide to allow large current flow. Put enough multiply-layer pads when they need to change the trace layer.
- Connect the input capacitor C1 to the VIN pin as closely as possible to get good power filter effect.

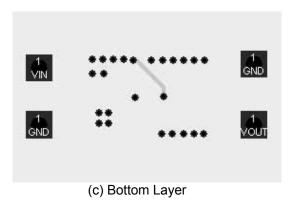
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- 3. Keep the switching node, SW, away from the sensitive FB node.
- 4. Do not trace signal line under inductor.







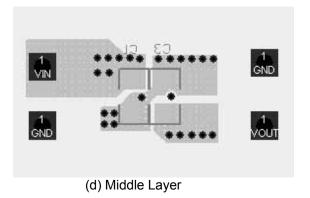


Figure 3. GX3410 Four Layers Layout Example, with the 2<sup>nd</sup> and 3<sup>rd</sup> Internal Plane GND

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# APPLICATIONS INFORMATION

Figure 4 below shows the basic application circuit with GX3410 fixed output versions.

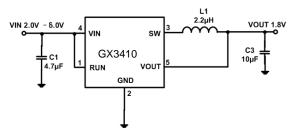


Figure 4. Basic Application Circuit with fixed output versions

### **Setting the Output Voltage**

Figure 1 above shows the basic application circuit with GX3410 adjustable output version. The external resistor sets the output voltage according to the following equation:

$$V_{OUT} = 0.6V \times \left(1 + \frac{R2}{R1}\right)$$

Table 1 Resistor select for output voltage setting

| $V_{OUT}$ | R1(R3) | R2(R4) |
|-----------|--------|--------|
| 1.2V      | 100k   | 100k   |
| 1.5V      | 100k   | 150k   |
| 1.8V      | 100k   | 200k   |
| 2.5V      | 100k   | 316k   |
| 3.3V      | 100k   | 453k   |

Note: R1 Resistor must be lower than 100K.

#### Inductor Selection

For most designs, the GX3410 operates with inductors of  $1\mu H$  to  $4.7\mu H$ . Low inductance values are physically smaller but require faster switching, which results in some efficiency loss. The inductor value can be derived from the following equation:

$$L = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times \Delta I_L \times f_{OSC}}$$

Where  $\Delta I_L$  is inductor Ripple Current. Large value inductors lower ripple current and small value inductors result in high ripple currents. Choose inductor ripple current approximately 35% of the maximum load current 1000mA, or  $\Delta I_L$  =210mA.

For output voltages above 2.0V, when light-load efficiency is important, the minimum recommended inductor is 2.2µH. For optimum voltage-positioning load transients, choose an inductor with DC series resistance in the  $50m\Omega$ to  $150m\Omega$  range. For higher efficiency at heavy loads (above 200mA), or minimal load regulation (but some transient overshoot), the resistance should be kept below  $100m\Omega$ . The DC current rating of the inductor should be at least equal to the maximum load current plus half the ripple prevent current to core saturation (900mA+105mA). Table 2 lists some typical surface mount inductors that meet target applications for the GX3410.

Table 2. Typical Surface Mount Inductors

| Part #             | L<br>(µH)                | Max<br>DCR<br>(mΩ)            | Rated<br>D.C.<br>Current<br>(A) | Size<br>WxLxH<br>(mm) |
|--------------------|--------------------------|-------------------------------|---------------------------------|-----------------------|
| Sumida<br>CR43     | 1.4<br>2.2<br>3.3<br>4.7 | 56.2<br>71.2<br>86.2<br>108.7 | 2.52<br>1.75<br>1.44<br>1.15    | 4.5x4.0x3.5           |
| Sumida<br>CDRH4D18 | 1.5<br>2.2<br>3.3<br>4.7 | 75<br>110<br>162              | 1.32<br>1.04<br>0.84            | 4.7x4.7x2.0           |
| Toko<br>D312C      | 1.5<br>2.2<br>3.3<br>4.7 | 120<br>140<br>180<br>240      | 1.29<br>1.14<br>0.98<br>0.79    | 3.6x3.6x1.2           |

#### **Input Capacitor Selection**

The input capacitor reduces the surge current drawn from the input and switching noise from the device. The input capacitor impedance at the switching frequency shall be less than input source impedance to prevent high frequency switching current passing to the input. A low ESR input capacitor sized for maximum RMS current must be used. Ceramic capacitors with X5R or X7R dielectrics are highly recommended because of their low ESR and small temperature coefficients. A  $4.7\mu F$  ceramic capacitor for most applications is sufficient.

#### **Output Capacitor Selection**

The output capacitor is required to keep the output voltage ripple small and to ensure regulation loop stability. The output capacitor must have low impedance at the switching frequency. Ceramic capacitors with X5R or X7R dielectrics are recommended due to their low

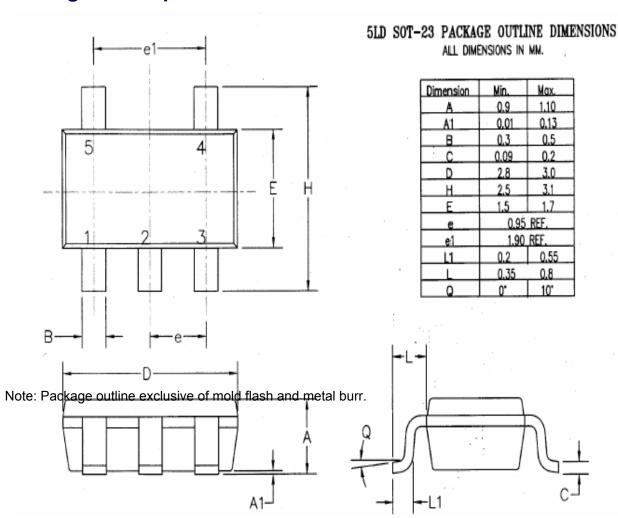
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ESR and high ripple current. The output ripple  $V_{\text{OUT}}$  is determined by:

$$\Delta V_{oUT} \leq \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times f_{oSC} \times L} \times \left(ESR + \frac{1}{8 \times f_{osc} \times C3}\right)$$

# **Package Description SOT23-5**



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